Sincom

ISSUEL

25 FEB 2005

SINCOM INDUCTIVE TECH.

**Approval Specifications** 

CUSTOMER

Digi Key

PART NAME

CHIP CHOKE COIL

CUSTOMER PART No.

ELC3GNOODO

MATSUSHITA PART No. : ELC3GNDDDD

MODEL NAME / No.

MANUFACTURED IN

: INDONESIA

**CUSTOMER'S ACKNOWLEDGEMENT** 

PLEASE RETURN ONE COPY

MATSUSHITA ELECTRONIC COMPONENTS (S) PTE. LTD.

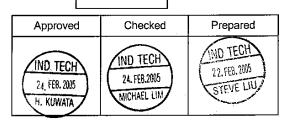
No. 3 BEDOK SOUTH ROAD, SINGAPORE 469269

FAX: 62418954

TEL: 62495176

SPEC SERIAL NO.:

T1S - 05011



21.05.03 (R-1)

 この製品の使用材料は、「化学物質の審査及び製造等の規制に関する法律」 に基き、すべて既存化学物質として記載されている材料です。

All the materials used in this product are registered material under the Law Concerning the Examination and Regulation of Manufacture, etc. of Chemical Substances.

 本製品は、モントリオール議定書で規制されているオゾン層破壊物質(ODC) を製造工程及び購入部品・材料で一切使用していません。

This product has not been manufactured with any ozone depleting chemical controlled under the Montreal Protocol.

3. この製品に使用している全ての材料には、臭素系特定難燃物質「PBBOs、 PBBe」を含有しておりません。

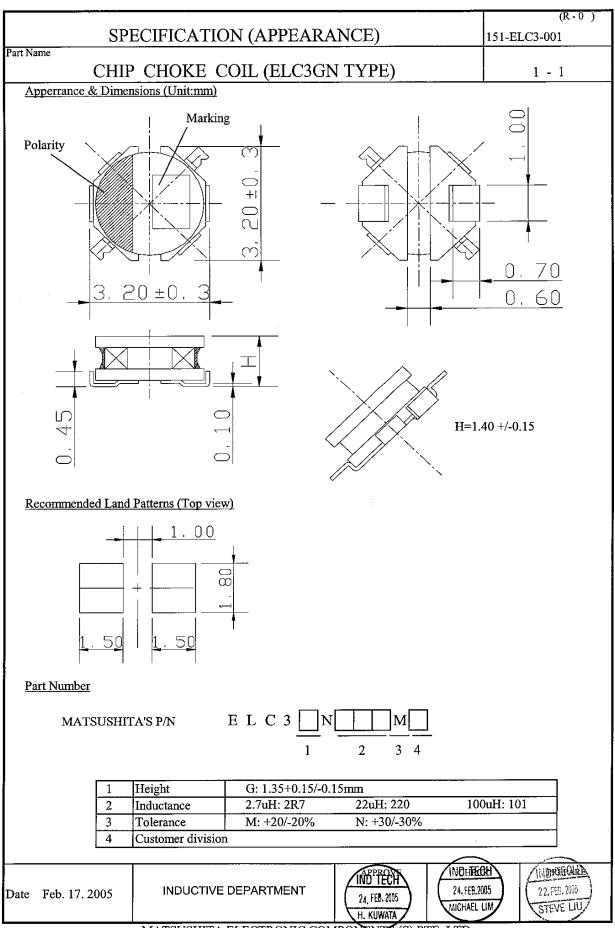
All the materials used in this product contain no brominated materials of PBBOs or PBBs as the flame-retardant.

4. 納入仕様용の「有効期間」について 有効期間は、特に、申し出のない限り(お客様の要望を含み)自動更新とします。 その際、連絡書・仕様書は、発行致しません。

"The Term of Validity" of Product Specifications for Information Unless otherwise requested (including from customer), the term of validity shall be renewed automatically.

Then, informations and specifications shall be not issued.

5. Refer to "113-TEC-001" for ERS issues



|           |                               | (R- 0 )      |
|-----------|-------------------------------|--------------|
|           | SPECIFICATION                 | 151-ELC3-006 |
| Part Name |                               |              |
|           | CHIP CHOKE COIL (ELC3GN TYPE) | 1 - 1        |

### Electrical Characteristics

| CUSTOMER'S  | MATSUSHITA'S | INDUCTANCE |       | DCR(20degC) |      | *RATED  | MARKING |
|-------------|--------------|------------|-------|-------------|------|---------|---------|
| PART NUMBER | PART NUMBER  | NOMINAL    | TOL.  | NOMINAL     | TOL. | CURRENT |         |
|             |              | [uH]       |       | [ohm]       |      | [mA]    |         |
| ELC3GN1R0N  | ELC3GN1R0N   | 1          |       | 0.64        |      | 1300    | Α       |
| ELC3GN1R6N  | ELC3GN1R6N   | 1.6        |       | 0.83        |      | 1200    | C       |
| ELC3GN2R2N  | ELC3GN2R2N   | 2.2        |       | 0.10        |      | 1000    | D       |
| ELC3GN3R3N  | ELC3GN3R3N   | 3.3        | ±30%  | 0.13        |      | 970     | Е       |
| ELC3GN4R7N  | ELC3GN4R7N   | 4.7        |       | 0.20        |      | 760     | H       |
| ELC3GN6R8N  | ELC3GN6R8N   | 6.8        |       | 0.25        |      | 680     | K       |
| ELC3GN8R2N  | ELC3GN8R2N   | 8.2        |       | 0.41        | !    | 540     | L       |
| ELC3GN100M  | ELC3GN100M   | 10         |       | 0.43        |      | 530     | M       |
| ELC3GN150M  | ELC3GN150M   | 15         |       | 0.60        | ±20% | 430     | 0       |
| ELC3GN220M  | ELC3GN220M   | 22         | ±20%  | 0.95        |      | 330     | R       |
| ELC3GN330M  | ELC3GN330M   | 33         | 12070 | 1.40        |      | 280     | T       |
| ELC3GN470M  | ELC3GN470M   | 47         |       | 1.95        |      | 240     | V       |
| ELC3GN680M  | ELC3GN680M   | 68         |       | 3.00        |      | 190     | X       |

#### \*Rated Current

The maximum allowable current is a DC current which causes a 30% inductance reduction from its nominal value or coil temperature to rise 45degC whichever smaller.

(Reference ambient temperature 20degC)

TEST CONDITION (INDUCTANCE) 100kHz, 0.3Vrms

# SPECIFICATION

(151-ELL4-022)

(R-1)

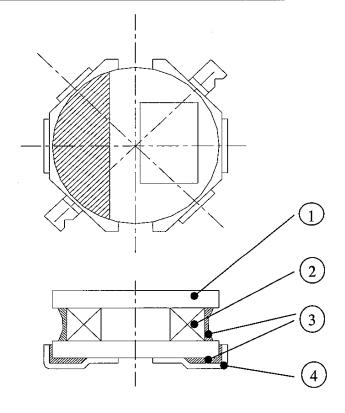
# CHIP CHOKE COIL RELIABILITY CHARACTERISTICS

| ITEM                          |  | SPECIFICATION  | TEST METHOD / CONDITION  |  |
|-------------------------------|--|--|--|--|
|                               | Appearance And Structure   | <ul><li>(1) The appearance shall be no damage practically harmful.</li><li>(2) Other items shell be in accordance with the appearance and the structure in the individual specification.</li></ul> |  |  |
| Insulation Resistance         |  | More than 100 [Mohm]   | After applying DC 100[V].  |  |
| Withstand Voltage             |  | There shall be no abnormal.  | After applying DC 100V for 60 [s].  Between core and coil.   |  |
| Op                            | perating temp.   | -40 to 105 [degC] (Including self - temperature rise)  | Detrical colo dia con  |  |
|                               | (1)There shall not be case deformation or change in appearance.  Moisture Life (2)There shall be no shorting or disconnection. |  | With rated current applied, coil shall be subjected to 90 to 95% [RH] at 60 +/- 2 degC for 500+/-8 [h]. Measurements shall be made after 1]h] stabilization at room temperature. |  |
| ENVIRONMENTAL CHARACTERISTICS | High Temp. Life  | (1)There shall not be case deformation or change in appearance. (2)There shall be no shorting or disconnection.  | With rated current applied, coil shall be stored at 85+/-2 [degC] for 500+/-8 [h]. Measurements shall be made after 1[h] stabilization at room temperature.                      |  |
|                               | Cold Resistance  | Inductance shall not change more than +/-10%   | Coil shall be stored at -40+/-2 [degC] for 500+/-8 [h].  Measurements shall be made after 1 [h]. stabilization at room temperature.  |  |
|                               | Heat Resistance  | Inductance shall not change more than +/-10%   | Coil shall be stored at 85+/-2 [degC] for 500+/-8 [h].  Measurements shall be made after 1 [h]. stabilization at room temperature.   |  |
|                               | Moisture<br>Resistance   | (1)Inductance shall not change more than +/-10% (2)There shall be no abnormal in withstand voltage.  | Coil shall be subjected to 95 to 95%RH at 60+/-2 [degC] for 500+/-8 [h].  Measurements shall be made after 1 [h]. stabilization at room temperature.                             |  |
|                               | Thermal Shock  | (1)There shall not be case deformation or change in appearance.  (2)Inductance shall not change more than +/-10%   | -40+/-2degC(for 0.5h) <=> 85+/-2degC(for 0.5h)<br>10 cycles.<br>Measurements shall be made after 1 [h].<br>stabilization at room temperature.                                    |  |
|                               | Temp.<br>Characteristics   | Inductance shall not change more than +/-15%   | -25 to 85 [degC] Standard: Values at 20 [degC] (at Idc=0 [A])  |  |
| PHYSICAL CHARACTERISTICS      | Vibration<br>Resistance  | (1)There shall not be case deformation or change in appearance.  (2)Inductance shall not change more than +/- 10%  | After vibrating at frequencies ranging from 10 to 55 [Hz] (10 to 55 to 10/min.) with amplitude for 1.5 [mm] for 2+/-0.1[h] each X-Y-Z axis.                                      |  |
|                               | Terminal Strength  | Terminal shall not come out.   | Pulling strength of terminal: 0.98[N]{ 0.1kgf} for 30 [s]  |  |
|                               | Solderability Solder shall be attached more than 90% around the dipped portion.  |  | After fluxing, coil shall be dipped in a melted solder bath(M705) at 255±5 [°C] for 3±0.5 [s]  |  |
|                               | Soldering<br>Heat Resistance   | (1)There shall not be case deformation or change in appearance.  (2)Inductance shall not change more than +/- 10%  | The coil shall be subjected to reflow soldering 2times.  Measurements shall be made after 1 [h]. stabilization at room temperature.  Reflow soldering:                           |  |
| PH                            |  |  | Preheating:150±10 [°C],3 [min]. Solder dipping:250±10 [°C],10±0.5 [s]  |  |

|   | SPEC  | IFICATION (COMMON)  | (R-1)<br>151-ELC3-003                      |  |
|---|---|---|--|--|
| CF  | 1 — 1   |   |  |  |
| ITEM  |   | REMARKS   |  |  |
| REFLOW<br>SOLDERING   | 260degC<br>230degC<br>170degC<br>150degC  | CONTENTS  EFLOW FURNACE.  (Preheating) 1 to 3min 30sec. Max. More than 2min.  Derature: 260degC max 200degC: 80 sec max | Products PC board  Reflow soldering should |  |
| WA GWDIG OF   | When the soldered   | PC board washed by fleon or others, you   | be limited to 2times.                      |  |
| WASHING OF  | are requested to con  | tact engineering department as for  |  |  |
| BOARD   |   | conditions advance.   |  |  |
| RESOLDERING WITH A<br>SOLDERING IRON  | The temperature of the tip of the soldering iron should be  RESOLDERING WITH A  SOLDERING IRON  And resoldering with a soldering iron should be limited to  1 time, and after that should be cooling these. |   |  |  |
| MOUNTING SIDE   | External force must   | be less than 5.0 [N] : while mounting.  |  |  |
| OTHERS  1 . Don't make  |   |   |  |  |
| <ol> <li>Don't heap up the coil.</li> <li>Be careful not to pressing force to the terminal.</li> <li>Don't use the coil dipped on the floor.</li> </ol> |   |   |  |  |
| DATE 24-Feb-2   | 2005  | INDUCTIVE DEPARTMET   |  |  |

|           |                               | (R - 0 )     |
|-----------|-------------------------------|--------------|
|           | SPECIFICATION (MATERIAL)      | 151-ELC3-004 |
| Part Name | CHIP CHOKE COIL (ELC3*N TYPE) | 1 - 1        |

#### Structure



# Material List

| ITEM | PART NAME | MATERIALS                            | MANUFACTURE  |
|------|-----------|--------------------------------------|--|
| 1    | Core      | Ferrite                              | TDK CO.,LTD. HITACHI METALS LTD. FDK CO.,LTD. ZHEJIANG TIANTONG ELECT. CO.,LTD HUOH YOW ENTERPRISE CO.,LTD |
| 2    | Coil      | Polyurethane Enameled<br>Copper Wire | RIKEN ELECTRIC WIRE CO.,LTD. TOUTOKU ELECTRIC CO.,LTD. DAIICHI DENKO CO.,LTD. HITACHI DENNSENN LTD.        |
| 3    | Adhesive  | Epoxy Resin                          | OPTIONAL   |
| 4    | Terminal  | Phosphor Bronze                      | OPTIONAL   |

Date Feb. 17. 2005

INDUCTIVE DEPARTMENT

IND TECH

24, FEB. 2005

H. KUWATA

INDCTEER 24. FEB. 2005 MICHAEL LIM



MATSUSHITA ELECTRONIC COMPONENTS (S) PTE. LTD.

# (R-0)SPECIFICATION (PACKAGING) 151-ELC3-005 Part Name CHIP CHOKE COIL (ELC3GN TYPE) 2 - 1 **Taping** (1) CARRIER TAPE DIMENSIONS. 1. 70±0.3 0. 40±0.1 A-A' SECTION (2) COVER TAPE PEEL STRENGTH AND TEST METHOD PEEL SPEED: 300mm/min PEEL STRENGTH: 0.1 to 1.07N Angle: 10 deg (3) PACKAGING **INDUCTORS EMPTY LEADER** TRAILER **POCKETS EDGE** DIRECTION **FEED** More than 400mm More than 100mm INDUCTIVE DEPARTMENT Date Feb. 17. 2005

MATSUSHITA ELECTRONIC COMPONENTS (S) PTE. LTD.

